Nadcap℠
Administered by PRI

This certificate is granted and awarded by the authority of the Nadcap Management Council to:

Pro-Active Engineering, LLC, dba Analog Technologies

11481 Rupp Drive
Burnsville, MN 55337
United States

This certificate demonstrates conformance and recognition of accreditation for specific services, as listed in www.eAuditNet.com on the Qualified Manufacturer's List (QML), to the revision in effect at the time of the audit for:

Electronics - Printed Board Assemblies

Certificate Number: 10484235486
Expiration Date: 31 May 2027
Accreditation Length: 18 Months

Jay Solomond
Executive Vice President & Chief Operating Officer

Performance Review Institute (PRI) | 161 Thorn Hill Road | Warrendale, PA 15086-7527

SCOPE OF ACCREDITATION

Electronics - Printed Board Assemblies

Pro-Active Engineering, LLC, dba Analog Technologies
11481 Rupp Drive
Burnsville, MN 55337

This certificate expiration is updated based on periodic audits. The current expiration date and scope of accreditation are listed at: www.eAuditNet.com - Online QML (Qualified Manufacturer Listing).

In recognition of the successful completion of the PRI evaluation process, accreditation is granted to this facility to perform the following:

AC7000 Rev A - AUDIT CRITERIA FOR NADCAP ACCREDITATION

AC7120 Rev F - Nadcap Audit Criteria for Printed Board Assemblies (to be used on/AFTER 21-Sep-2025) (CANNOT BE COMBINED WITH AC7119 or AC7121)

Automated Optical Inspection (AOI)
Bonding
Compliant Pin (Press Fit) Connector Installation
Component Programming
Electrical Testing Flying Probe
General Printed Board Assemblies (Select if no other options apply)
Jumper Wire Installation
Kitting
Mechanical Part Installation
Moisture Sensitive Components and Materials
Stranded Wire Tinning
Wire Cutting & Stripping
X–Ray

AC7120/2 Rev A - General Soldering of Printed Board Assemblies (to be used on/AFTER 21-Sep-2025)

Build Through / Build Short
Clinched Component Leads
Electronic Component Preparation for Preassembly Process
General Soldering of Printed Board Assemblies (Select if no other options apply)
Gold Removal
Hand Soldering
Part Placement: Manual

AC7120/3 Rev A - Plated Through Hole Technology (requires AC7120/2) (to be used on/AFTER

21-Sep-2025)
Selective Soldering

AC7120/4 Rev B - Surface Mount Technology (requires AC7120/2) (to be used on/AFTER 21-Sep-2025)
General Surface Mount Technology (Select if no other options apply)
Solder Paste: Stencil Printing

AC7120/7 Rev B - Conformal Coating of Printed Board Assemblies (to be used on/AFTER 21-Sep-2025)
Conformal Coating of Printed Board Assemblies